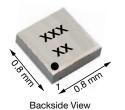
Si8817DB

www.vishay.com



PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A) ^{a, e}	Q _g (Typ.)			
-20	0.076 at V _{GS} = -4.5 V	-2.9				
	0.100 at V _{GS} = -2.5 V	-2.5	7.5 nC			
	0.145 at V_{GS} = -1.8 V -2.1		7.5 10			
	0.320 at V _{GS} = -1.5 V	-0.5				

MICRO FOOT® 0.8 x 0.8





Marking Code: xx = AF

xxx = Date/Lot traceability code

Ordering Information:

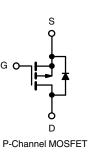
Si8817DB-T2-E1 (lead (Pb)-free and halogen-free)

FEATURES

- TrenchFET[®] power MOSFET
- Small 0.8 mm x 0.8 mm outline area
- Low 0.4 mm max. profile
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Load switches and chargers switches
- Battery management
- DC/DC converters
- For smart phones and tablet PCs



ABSOLUTE MAXIMUM RATINGS (T	A = 25 °C, unless	otherwise not	ed)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	-20	v
Gate-Source Voltage		V _{GS}	± 8	v
	T _A = 25 °C		-2.9 ^a	
Continuous Drain Current (T. -150 °C)	$T_A = 70 \ ^\circ C$. [-2.3 ^a	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	ID	-2.1 ^b	
	$T_A = 70 \ ^\circ C$		-1.7 ^b	А
Pulsed Drain Current (t = 300 μs)		I _{DM}	-15	
Continuous Source-Drain Diode Current	T _C = 25 °C		-0.7 ^a	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S –	-0.4 ^b	
	T _A = 25 °C		0.9 ^a	
Maximum Davier Diacia atian	T _A = 70 °C		0.6 ^a	w
Maximum Power Dissipation	T _A = 25 °C	PD	0.5 ^b	vv
	T _A = 70 °C		0.3 ^b	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150	
Package Reflow Conditions ^c	VPR		260	°C
	IR/Convection		260	

Notes

- a. Surface mounted on 1" x 1" FR4 board with full copper, t = 5 s.
- b. Surface mounted on 1" x 1" FR4 board with minimum copper, t = 5 s.
- c. Refer to IPC/JEDEC® (J-STD-020), no manual or hand soldering.
- d. In this document, any reference to case represents the body of the MICRO FOOT device and foot is the bump.

e. Based on $T_A = 25$ °C.

1



COMPLIANT

HALOGEN



THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum Junction-to-Ambient a, b	t = 5 s	Р	105	135	°C/W		
Maximum Junction-to-Ambient ^{c, d}	t = 5 s	R _{thJA}	200	260	0/10		

Notes

a. Surface mounted on 1" x 1" FR4 board with full copper.

b. Maximum under steady state conditions is 185 $^{\circ}\text{C/W}.$

c. Surface mounted on 1" x 1" FR4 board with minimum copper.

d. Maximum under steady state conditions is 330 °C/W.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	-					•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	-20	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	lo = -250 uA	-	-12	-	mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	2.5	-		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-0.4	-	-1	V	
Gate-Source Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 8 V	-	-	± 100	nA	
Zara Cata Valtaga Drain Current		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	μA	
Zero Gate Voltage Drain Current	IDSS	V_{DS} = -20 V, V_{GS} = 0 V, T_{J} = 70 °C	-	-	-10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}$	-5	-	-	A	
		$V_{GS} = -4.5 \text{ V}, I_D = -1 \text{ A}$	-	0.061	0.076	Ω	
Drain Source On State Desistance a		$V_{GS} = -2.5 \text{ V}, I_D = -1 \text{ A}$	-	0.080	0.100		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -1.8 \text{ V}, I_D = -0.5 \text{ A}$	-	0.110	0.145		
		$V_{GS} = -1.5 \text{ V}, \text{ I}_{D} = -0.5 \text{ A}$	-	0.165	0.320		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ A}$	-	5	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	615	-	pF nC	
Output Capacitance	C _{oss}	V_{DS} = -10 V, V_{GS} = 0 V, f = 1 MHz	-	90	-		
Reverse Transfer Capacitance	C _{rss}		-	75	-		
Tatal Cata Charge	Qg	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -8 \text{ V}, \text{ I}_{D} = -1 \text{ A}$	-	12.5	19		
Total Gate Charge			-	7.5	12		
Gate-Source Charge	Q _{gs}	V_{DS} = -10 V, V_{GS} = -4.5 V, I_D = -1 A	-	1	-		
Gate-Drain Charge	Q _{gd}		-	1.9	-		
Gate Resistance	Rg	V _{GS} = -0.1 V, f = 1 MHz	-	14	-	Ω	
Turn-On Delay Time	t _{d(on)}		-	20	40		
Rise Time	t _r	$V_{DD} = -10 \text{ V}, \text{ R}_{\text{I}} = 10 \Omega$	-	20	40	-	
Turn-Off Delay Time	t _{d(off)}	$t_{d(off)}$ $I_D \cong -1$ Å, $V_{GEN} = -4.5$ V, $R_g = 1 \Omega$	-	52	100		
Fall Time	t _f		-	22	45		
Turn-On Delay Time	t _{d(on)}		-	6	15	ns	
Rise Time	t _r			10	20	1	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -1 \text{ A}, V_{\text{GEN}} = -8 \text{ V}, \text{R}_{\text{g}} = 1 \Omega$	-	60	120	-	
Fall Time	t _f		-	23	45		



Si8817DB

Vishay Siliconix

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT		
Drain-Source Body Diode Characteristics								
Continuous Source-Drain Diode Current	I _S			-	-0.7	A		
Pulse Diode Forward Current	I _{SM}			-	-15			
Body Diode Voltage	V _{SD}	$I_{\rm S} = -1$ A, $V_{\rm GS} = 0$ V	-	-0.75	-1.2	V		
Body Diode Reverse Recovery Time	t _{rr}		-	30	60	ns		
Body Diode Reverse Recovery Charge	Q _{rr}	l _F = -1 A, dl/dt = 100 A/μs, T ₁ = 25 °C	-	14	30	nC		
Reverse Recovery Fall Time	t _a	$F = -1 A$, $u/ut = 100 A/\mu s$, $T_{\rm J} = 25 C$	-	13	-	ns		
Reverse Recovery Rise Time	t _b		-	17	-	115		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

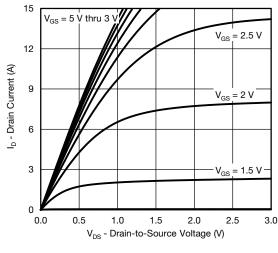
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Si8817DB

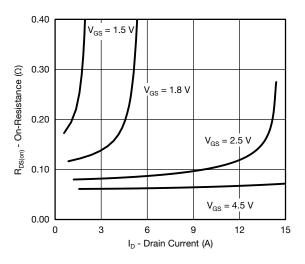




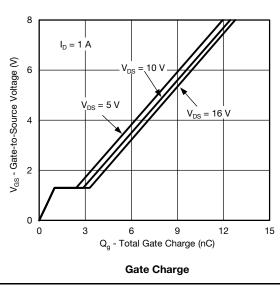
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







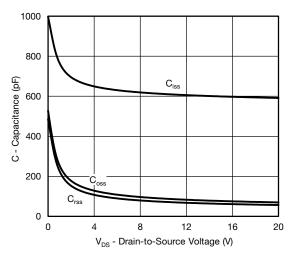
On-Resistance vs. Drain Current and Gate Voltage



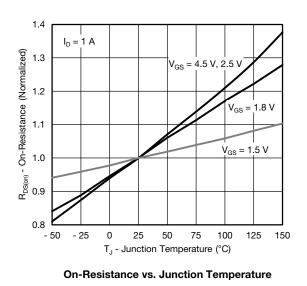
S15-0346-Rev. B, 23-Feb-15

10 8 I_D - Drain Current (A) 6 4 T_C = 25 °C = 125 °C $\Gamma_{\rm C}$ 2 - 55 °C 0 0.0 0.5 1.0 2.0 2.5 1.5 V_{GS} - Gate-to-Source Voltage (V)









Document Number: 62759

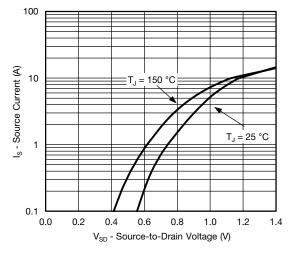
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4

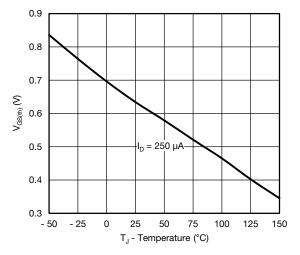




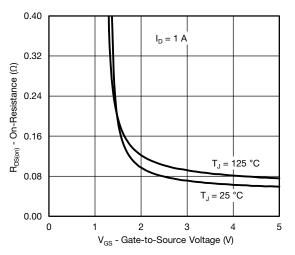
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



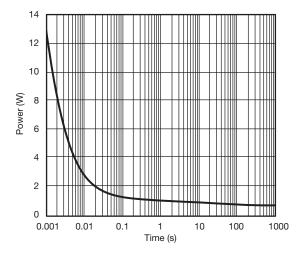
Source-Drain Diode Forward Voltage



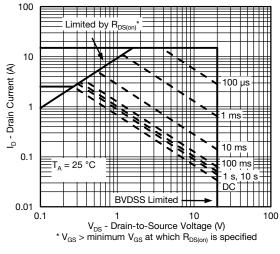




On-Resistance vs. Gate-to-Source Voltage



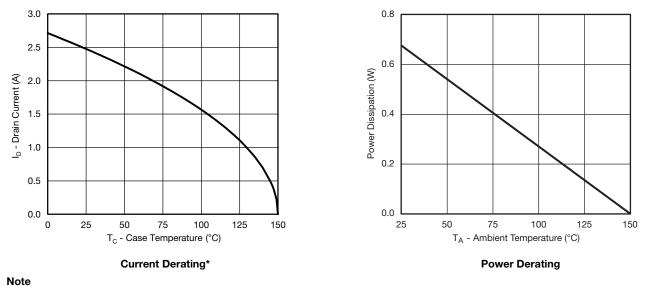
Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient 5



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

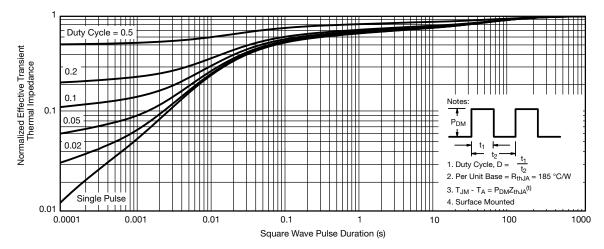


When mounted on 1" x 1" FR4 with full copper.

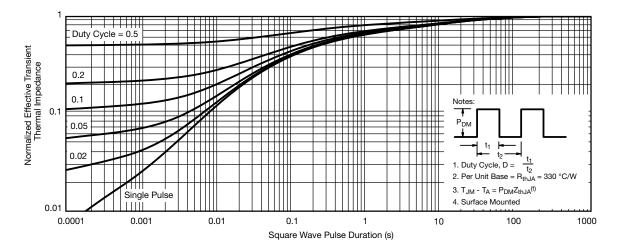
* The power dissipation P_D is based on T_{J (max.)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient (On 1" x 1" FR4 Board with Maximum Copper)



Normalized Thermal Transient Impedance, Junction-to-Ambient (On 1" x 1" FR4 Board with Minimum Copper)

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